AMENDMENTS TO THE SPECIFICATION

Please amend paragraph **0014** as indicated below:

-- As described above, because the chassis 3 is not normally air tight, the heated air exits the chassis 3 through any of a number of air outlets therein. However, by intentionally creating one or more air outlets 2 in the chassis 3, the bulk of the air inside the chassis 3 can be directed through those air outlets 2 instead of through other openings in the chassis 3. Air that enters the chassis 3 tends to heat up due to the hot electrical components inside the chassis. Therefore, the air is typically at its hottest just before it leaves the chassis 3. Some elements on the motherboard 4 could ~~should~~ be kept relatively hot, like less critical ~~heating~~ elements such as capacitors, while others should be kept as cool as possible, like a CPU or a graphics card. Accordingly, in one embodiment, the chassis 3 includes one or more air outlets 2 that are located near elements that could ~~should~~ be kept relatively hot, and located relatively far from components that should be cooled. This helps to direct the relatively hotter air near less critical ~~heating~~ elements and away from electrical components in the computer that should be cooled. --